

AMENDMENTS TO THE ABSTRACT

Please replace the abstract with the following substitute abstract.

~~The present invention is intended for providing a~~A component mounting apparatus and a component mounting method which improve an accuracy and a rate of placement of components on a circuit-formed member. A component ~~+~~sucked by a suction nozzle ~~5~~is recognized at a component recognizing position~~+~~~~10~~, a deviation ΔL of the component~~+~~ from a normal suction status~~+~~~~1b~~ is determined on the basis of component recognition information obtained from the recognition of the component, and a velocity of conveyance of the component~~+~~ for a period of time following the recognition of the component and preceding the placement of the component is controlled on basis of a magnitude of the deviation. By the control, the accuracy and rate of placement of the components~~+~~ on the circuit-formed member~~2~~ can be improved.